

4953B

### 4953B Dual P-Channel 20-V(D-S) MOSFET

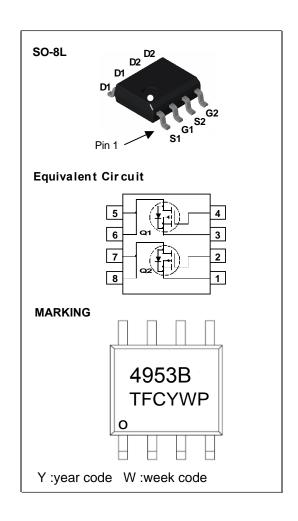
<b>V</b> (BR)DSS	R <sub>DS(on)</sub> MAX	lo	
-20V	0.070Ω@-4.5V		
	0.110Ω@-2.5V	-5.0A	

#### **General FEATURE**

- ●TrenchFET Power MOSFET
- •Lead free product is acquired
- Surface mount package

### **APPLICATION**

- ●Load Switch for Portable Devices
- ●DC/DC Converter



### Maximum ratings (T₂=25°C unless otherwise noted)

		1	
Parameter	Symbol	Value	Unit
Drain-Source Voltage	Vos	-20	V
Gate-Source Voltage	Vgs	±12	V
Continuous Drain Current	ΙD	-5. 0	
Pulsed Drain Current	Ірм	-10	Α
Continuous Source-Drain Diode Current	ls	-1.30	
Maximum Power Dissipation	PD	1.0	W
Thermal Resistance from Junction to Ambient(t ≤5s)	R 0JA	125	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	Tstg	-55 ~+150	℃



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Electrical Ch	naracteristics
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T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics			1	1	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	-20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V},  V_{GS} = 0 \text{ V}$			-1	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	$V_{GS} = -10 \text{ V},  V_{DS} = 0 \text{ V}$			-100	nA
$I_{GSSR}$	Gate–Body Leakage, Reverse	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
On Char	acteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-1.7	-3	V
1 403(011)	Static Drain–Source	$V_{GS} = -2.5 \text{ V},  I_D = -2.5 \text{ A}$		88	110	mΩ
	On–Resistance	$V_{GS} = -4.5 \text{ V},  I_D = -3.5 \text{ A}$		60	70	
I <sub>D(on)</sub>	On–State Drain Current	$V_{GS} = -4.5V$ , $V_{DS} = -4.5V$	-10			Α
<b>g</b> FS	Forward Transconductance	$V_{DS} = -5 \text{ V}, \qquad I_{D} = -2 \text{ A}$		5		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 \text{ V},  V_{GS} = 0 \text{ V},$		405		pF
Coss	Output Capacitance	f = 1.0 MHz		75		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			55		pF
Switchir	ng Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = -10 \text{ V}, \qquad I_D = -1 \text{ A},$		11		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = -4.5V$ , $R_{GEN} = 10\Omega$		35		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	1		30		ns
t <sub>f</sub>	Turn-Off Fall Time	1		10		ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = -10 \text{ V},  I_{D} = -3 \text{ A},$		3.3	12	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = -2.5 V$		0.7		nC
$Q_{gd}$	Gate-Drain Charge	1		1.3		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				-1.3	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, l <sub>S</sub> = -1.3 A		-0.8	-1.2	V

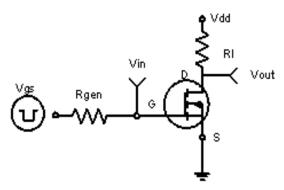
#### Notes

R<sub>QUA</sub> is the sum of the junction-to-case and case-to-ambient thermal rasistance where the case thermal reference is defined as the solder mounting surface of
the drain pins. R<sub>QUC</sub> is guaranteed by design while R<sub>QCA</sub> is determined by the user's board design.



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### **Typical Electrical and Thermal Characteristics**



V<sub>OUT</sub>

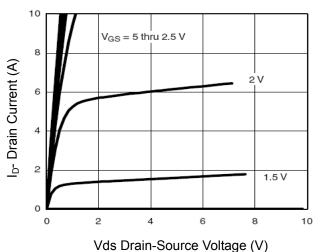
V<sub>IN</sub>

10%

PULSE WIDTH

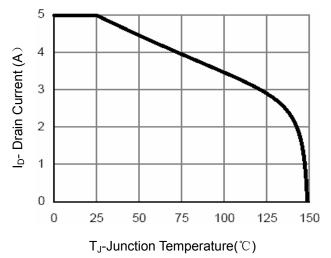
**Figure 1:Switching Test Circuit** 

Figure 3 Power Dissipation



**Figure 5 Output Characteristics** 





**Figure 4 Drain Current** 

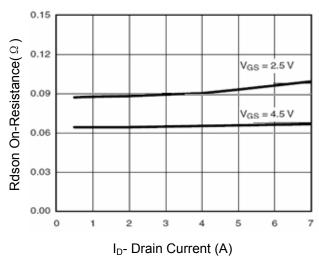
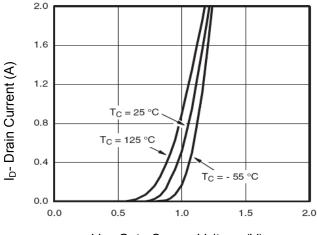


Figure 6 Drain-Source On-Resistance

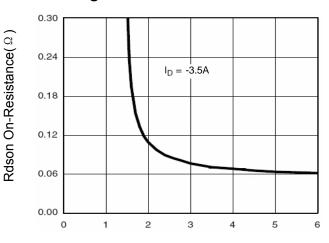


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Vgs Gate-Source Voltage (V)





Vgs Gate-Source Voltage (V)

### Figure 9 Rdson vs Vgs

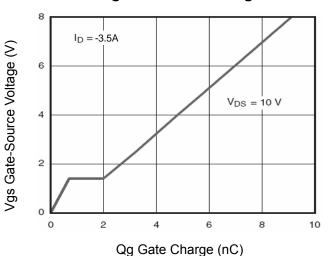
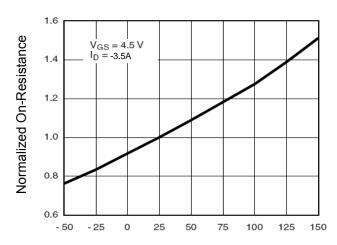
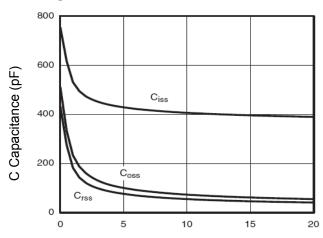


Figure 11 Gate Charge



 $T_J$ -Junction Temperature( ${}^{\circ}\mathbb{C}$ )

### Figure 8 Drain-Source On-Resistance



Vds Drain-Source Voltage (V)

#### Figure 10 Capacitance vs Vds

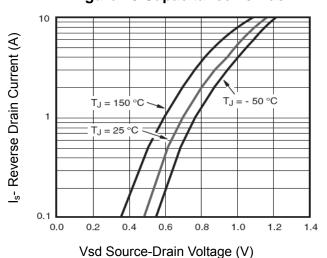
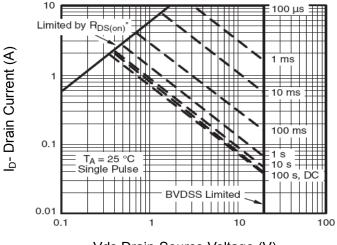


Figure 12 Source- Drain Diode Forward

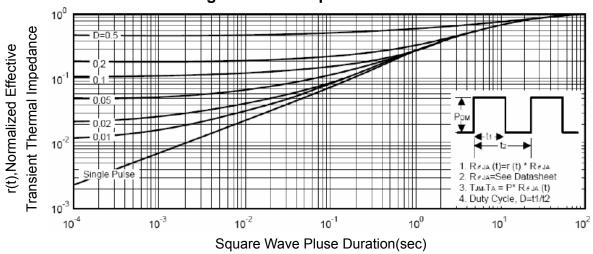


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Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area

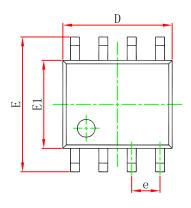


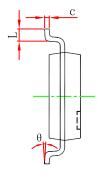
**Figure 14 Normalized Maximum Transient Thermal Impedance** 

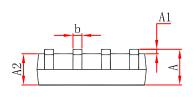


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### **SOP8 Package Outline Dimensions**

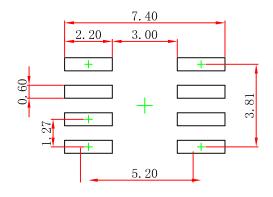






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1. 350	1.750	0.053	0.069	
A1	0.100	0. 250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0. 250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
Е	5.800	6. 200	0. 228	0. 244	
E1	3.800	4.000	0.150	0. 157	
L	0.400	1. 270	0.016	0.050	
θ	0°	8°	0°	8°	

### **SOP8 Suggested Pad Layout**



#### Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.

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